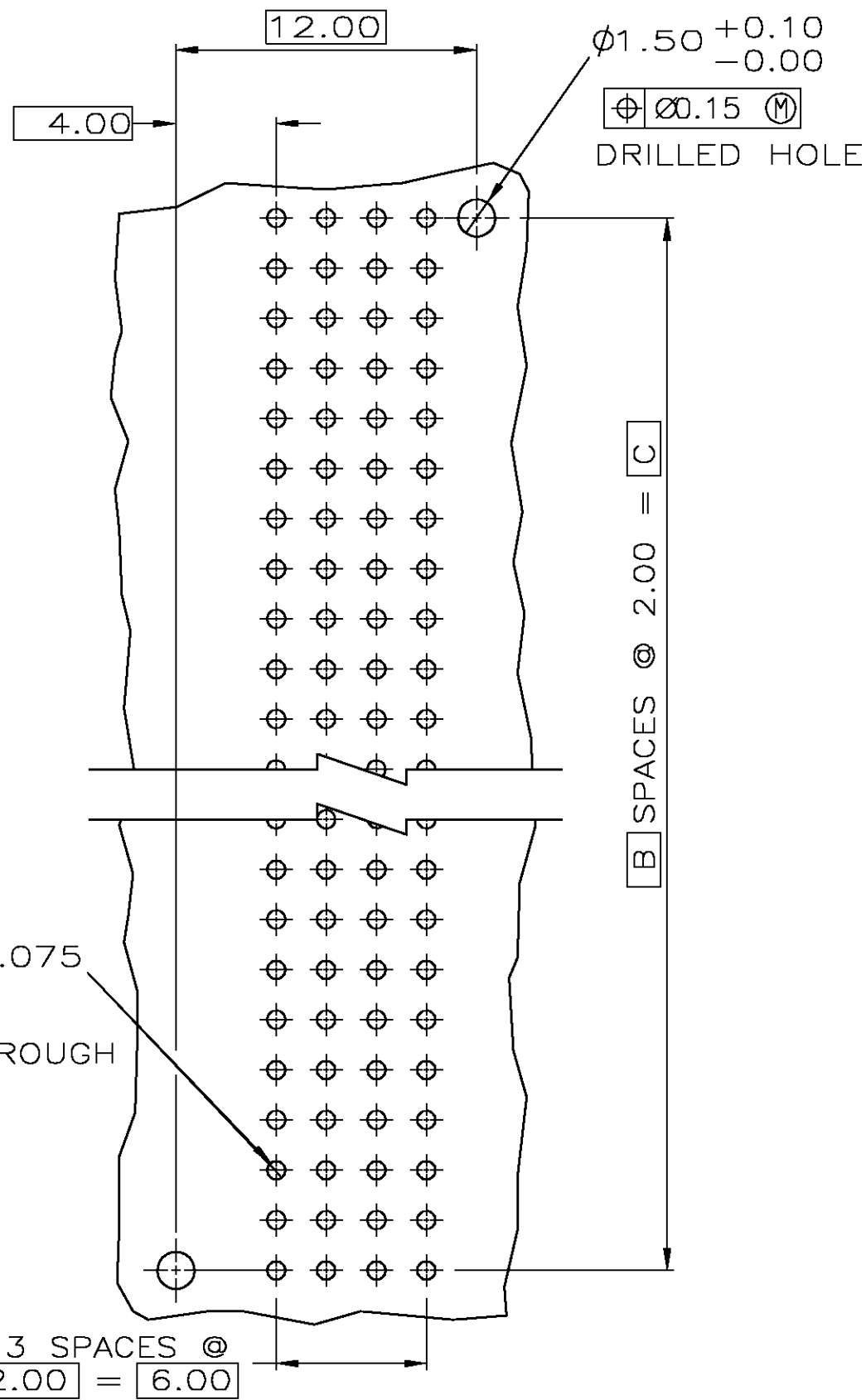
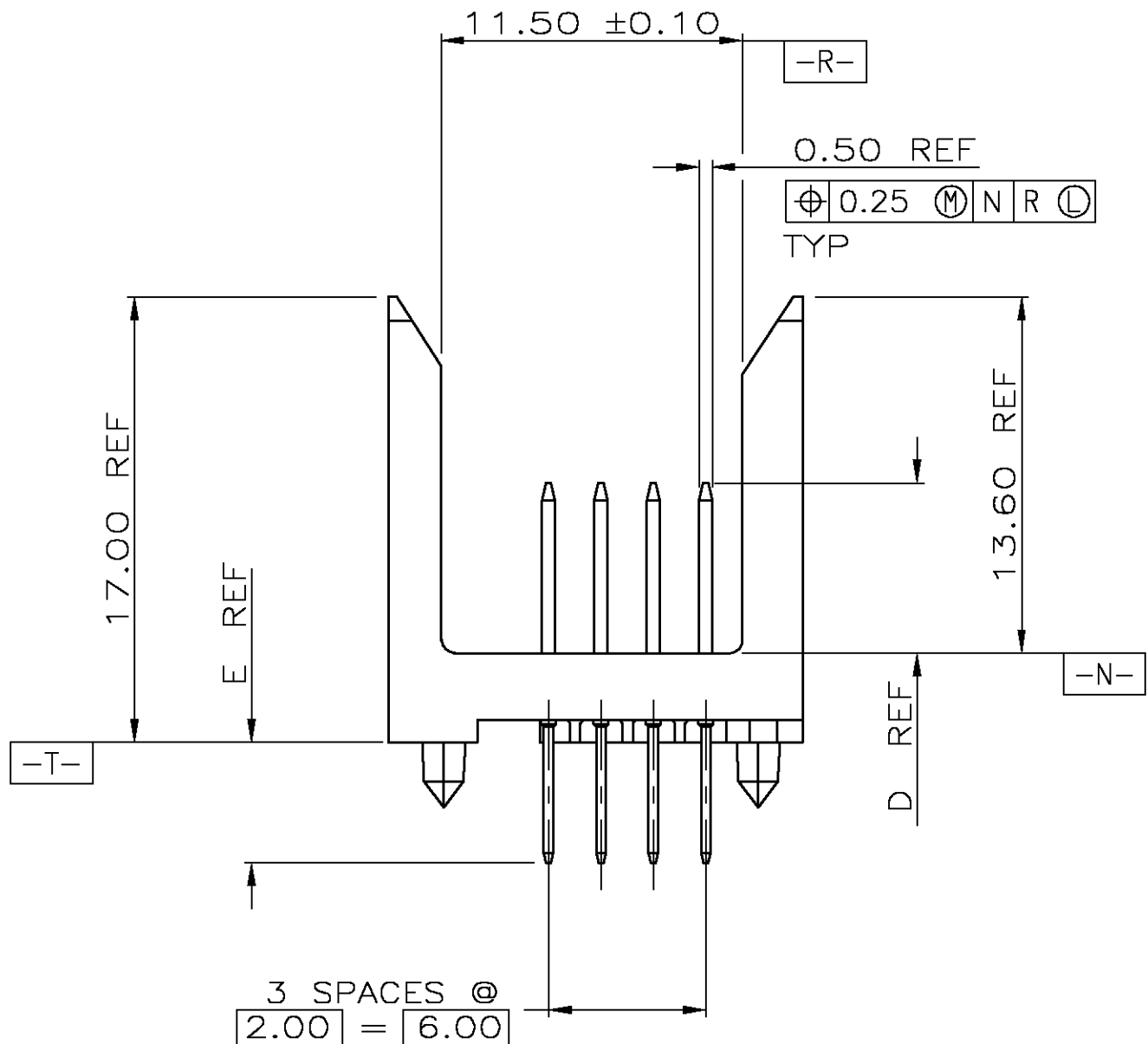
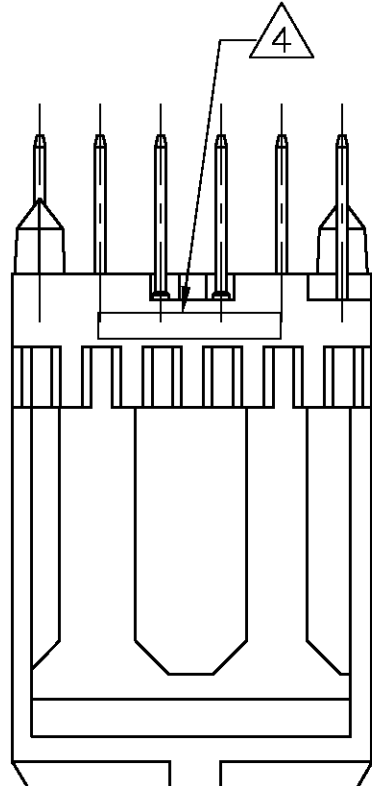
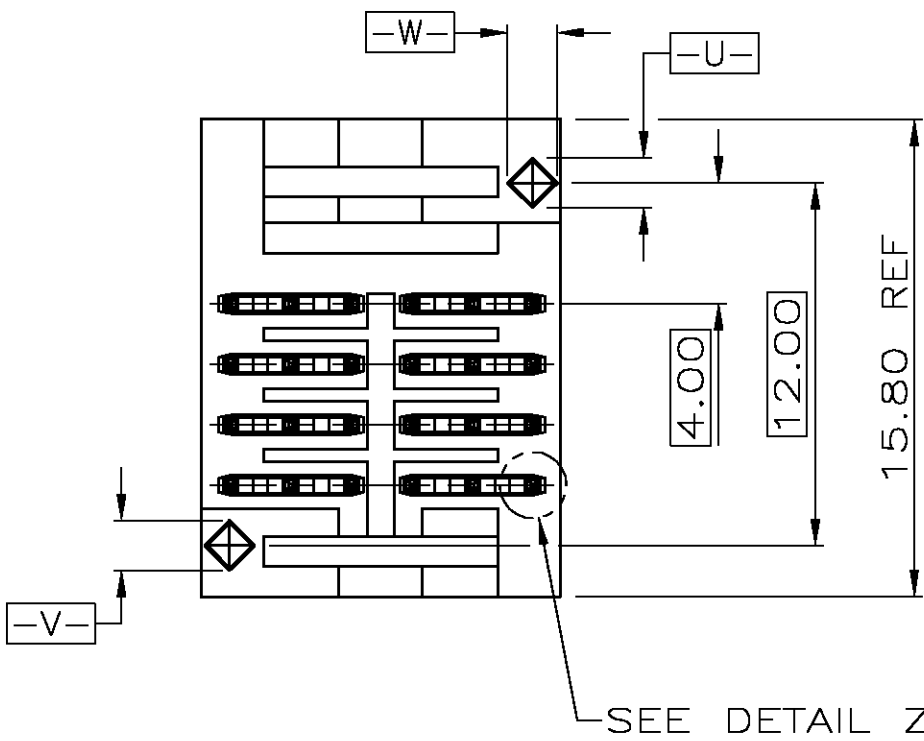
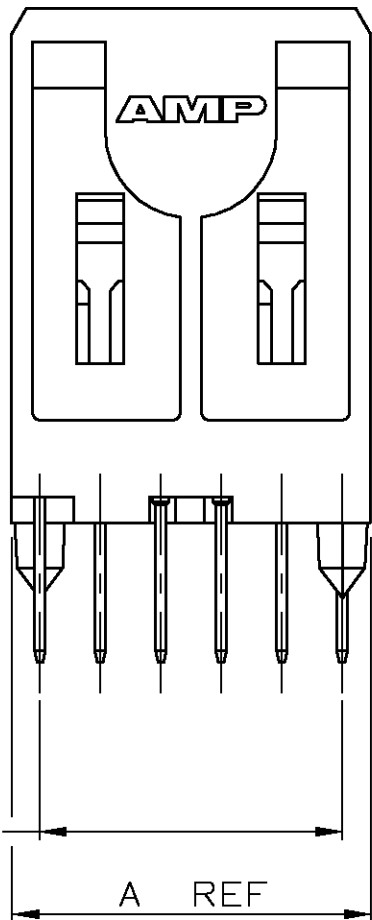
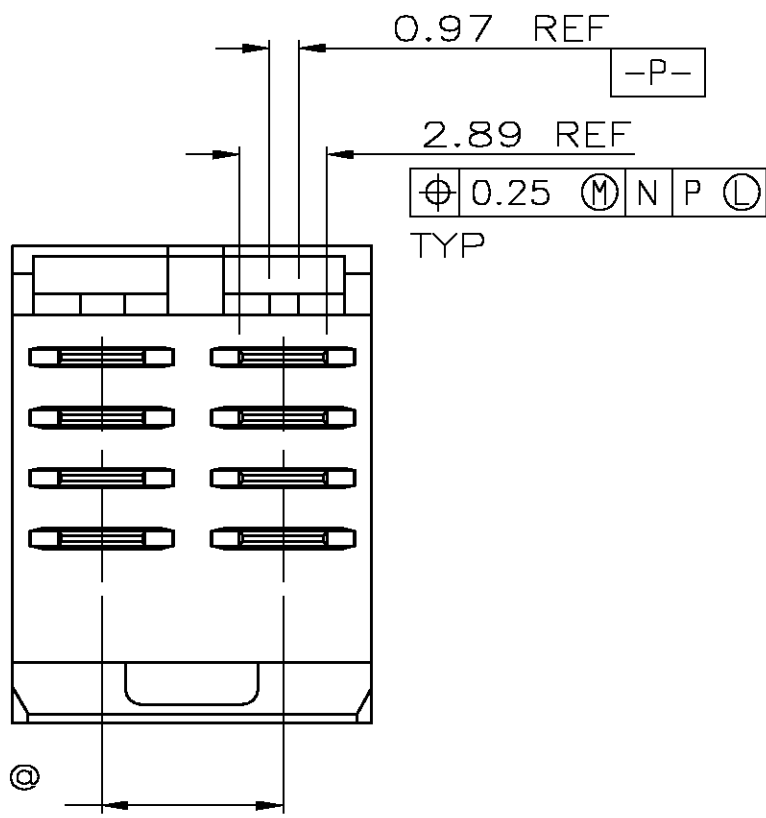
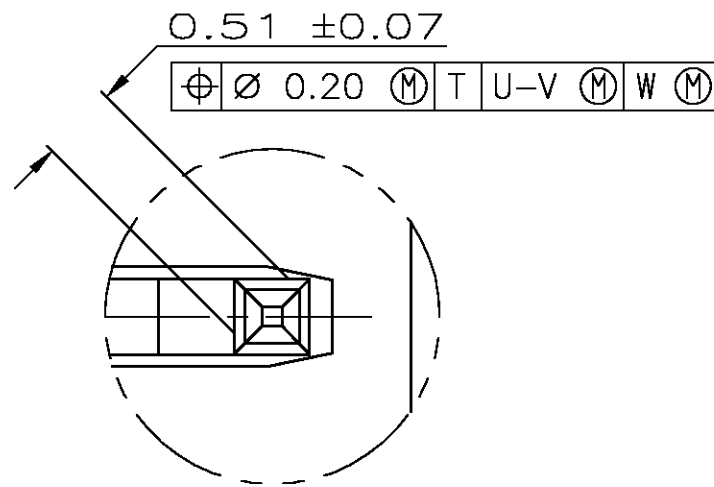


LOC		DIST		REVISIONS					
AD		00		P	LTR	DESCRIPTION	DATE	DWN	APVD
		0				RELEASED PER EC OS12-0235-04	27NOV00	BM	RW

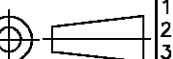


RECOMMENDED CIRCUIT PATTERN
PER IPC-D300 TYPE II, CLASS C
(COMPONENT SIDE)

- 1 HOUSING MATERIAL: LIQUID CRYSTAL POLYMER PER ASTM D5138 LCP000 G30A 32250.
- 2 CONTACT MATERIAL: PHOSPHOR BRONZE PER UNS ALLOY NO. C51100, TEMPER: H04.
- 3 CONTACT FINISH:(E)
UNDERPLATE (ENTIRE CONTACT):
0.00127 MIN NICKEL PER SAE-AMS-QQ-N-290
ON MATING SURFACES:
FLASH GOLD PER ASTM B 488, OVER
0.00076 MIN PALLADIUM-NICKEL OVER UNDERPLATE, OR
0.00076 MIN GOLD PER ASTM B 488 OVER UNDERPLATE.
ON LEADS:
0.00381 MIN MATTE TIN PER ASTM B 545 OVER UNDERPLATE.
LUBRICATION (MIN MATING SURFACES):
SURFACE CONDITIONER AFTER PLATING.
- 4 PART MARKING, LOCATED APPROXIMATELY AS SHOWN.



DETAIL Z
SCALE 20:1

6.00	1	4.25	6.50	10.00	5	11.83	3	8	5536600-1	
G	F	E	D	C	B	A	FINISH	NO OF POSN	PART NUMBER	
		THIS DRAWING IS A CONTROLLED DOCUMENT.				DIN D.R.BENDER 08/11/92		 Tyco Electronics Corporation Harrisburg, Pa 17105-3608		
		DIMENSIONS:		TOLERANCES UNLESS OTHERWISE SPECIFIED:		CIR R.L.BENDORF 09/03/92				
		mm				APVD				
						NAME				
				PRODUCT SPEC						
				APPLICATION SPEC						
		MATERIAL		FINISH		WEIGHT		SIZE CASE CODE DRAWING NO		RESTRICTED TO
		1 2		3		-		A1 00779C=5536600		-
CUSTOMER DRAWING								SCALE 4:1	SHEET 1 OF 1	REV 0